ON Semiconductor

Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,

AND8265/D

Typical FETKY Applications

Prepared by: Han Zou ON Semiconductor



ON Semiconductor®

http://onsemi.com

APPLICATION NOTE

Introduction

In consumer power electronics, it is not unusual to see both power MOSFETs and Schottky diodes operating side by side as main circuit elements. The reasons of placing power MOSFETs in conjunction with the Schottky diodes can be versatile, such as reverse current protection, DC/DC converter free—wheeling rectification (Asynchronous), switching efficiency improvement and so on. Working together, they could provide a more desirable system performance.

one standard package could bring benefits. From circuit design point of view, it can minimize the parasitic influence, save the board space, add convenience of PCB routing, and lowers down the total system cost. The integration results in a new device category: FETKY. This short note tries to cover typical applications of the FETKY devices in brief.

Needless to say, the integration of these two devices into

Applications

• DC/DC circuits: MOSFET + Schottky free-wheeling diode

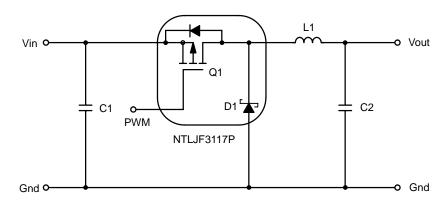


Figure 1. Buck Converter Circuit with μCool™ NTLJF3117P FETKY device

Two simple topologies frequently seen in the portable electronic DC/DC circuits probably are asynchronous buck and boost circuit where the integrated Schottky diode acts as a free-wheeling rectification diode to carry the current

during the time the FET is turned off. A low gate charge MOSFET and a low forward voltage Schottky diode ensure both fast switching and minimum power loss when the loading current is high.

AND8265/D

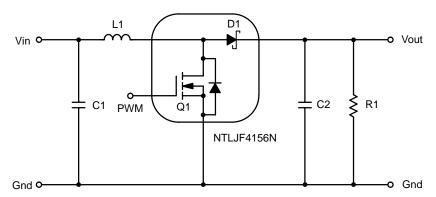


Figure 2. Boost Converter Circuit μCool™ NTLJF4156N FETKY device

The following example describes the method to estimate and evaluate the FETKY performance in an asynchronous DC/DC circuit design:

The objective is to design a 5 V input and 2.5 V output converter with a 45°C ambient temperature and 2 A maximum loading. The PWM controller operates at 700 kHz constant frequency with conversion duty cycle calculated as:

$$D = \frac{V_{out}}{V_{in}} = 50\%$$
 (eq. 1)

For a 700 kHz operating frequency with 50% duty cycle, the on–time is $0.7 \mu s$.

Referring to the thermal transient response curve in the FETKY device datasheet (WDFN6 2x2 NTLJF3117P), the thermal resistance for 50% duty cycle and 0.7 μ s on–time would be 80° C/W.

The elevated ambient temperature is 45°C, therefore, the max power loss on the FET is:

$$P_{dmax} = \frac{T_{j(max)} - T_{A}}{R_{\theta JA}} = \frac{150 - 45}{80} = 1.31 \text{ W}$$
 (eq. 2)

Assume that the gate voltage allows P–channel MOSFET to be fully conducted, the maximum $R_{DS(on)}$ according to the datasheet is $100~\text{m}\Omega$. With a 45°C ambient temperature, $R_{DS(on)}$ will be 8% higher than normal which is about $108~\text{m}\Omega$ (Figure 5 in the datasheet). The maximum loading current for the converter is 2~A. Therefore the real power consumption on the device can be calculated as:

$$PFET = RDS(on) \cdot I_{max}^2 = 0.45 W \qquad (eq. 3)$$

In conclusion, the FET would work in a safe region. From Figure 13 in the datasheet, the typical forward voltage

dropped on the Schottky diode at 2 A is less than 0.55 V, so the Schottky diode also works in its safe region. Overall, it is an applicable design if there is a secure thermal contact between FETKY and the PC board.

Routing of FETKY device in a DC/DC buck circuit:

In order to achieve good power efficiency, the drain pin of MOSFET needs to be placed as close as possible to the cathode pin of the Schottky diode to minimize the switching transient caused by the parasitic inductance. A recommendation for routing the FETKY device properly is illustrated as below:

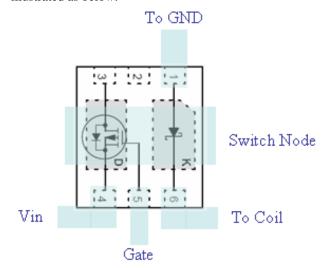


Figure 3. Recommended routing for the FETKY (WDFN6 2x2, NTLJF3117P) in a buck converter

Load Switches and Charging Circuits with Reverse Protection

A Schottky can be used in series with a power MOSFET as a blocking unit as shown in Fig. 4. This topology is often used in the Li-ion battery linear charging circuit for cellular phones. The power MOSFET acts as a charging element and the voltage across it varies with the battery voltage. The Schottky diode is then used to prevent the reverse current flow on the battery side when the charge input becomes

shorted accidentally. The routing for FETKY in charging circuit is a bit different from the DC/DC circuit with drain pin of the P-channel MOSFET connected to the anode of the Schottky diode from outside of the package, no switch node exists, but the distance between Drain and Anode needs to be as short as possible. A recommended routing scheme for this application is presented in Fig. 5.

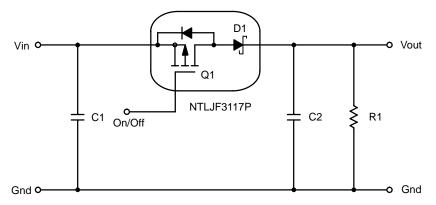


Figure 4. FETKY load switch with blocking diode

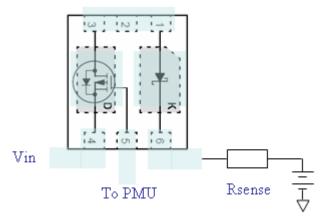


Figure 5. Recommended routing for FETKY (WDFN6 2x2, NTLJF3117P) in a linear battery charging circuit

The FETKY structure can also be utilized to protect itself from being damaged. If multiple power sources exist or the output voltage could be higher than the input voltage, the reverse current may flow through the body diode of the P-channel MOSFET causing irreversible damage to the MOSFET. A low voltage Schottky diode (0.4 V @ 1 A) in parallel with the FET will bypass the current and keep the reverse voltage across the switch less than a diode voltage drop, therefore greatly reduce the risk of damaging the power device.

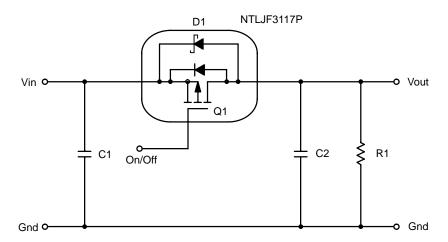


Figure 6. FETKY load switch with by-pass diode

AND8265/D

Switching Efficiency Improvement

In synchronous DC/DC buck converter circuit, a Schottky diode is placed in parallel with the synchronous rectifying MOSFET to improve efficiency. Due to the fast recovering feature of the Schottky diode, it becomes conducted first during the dead–time between the conduction of the two

power MOSFETs. This prevents the body diode of the bottom MOSFET from turning on and storing charge during the dead–time, which could cost as much as 2% in efficiency.

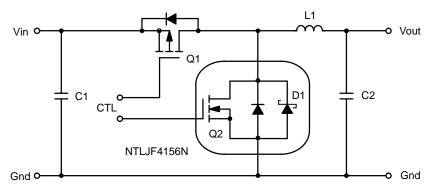


Figure 7. FETKY for efficiency improvement of synchronous DC/DC converter

To Switch Node

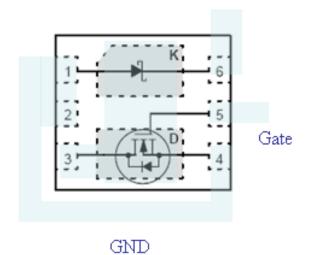


Figure 8. Recommended layout for FETKY (WDFN6 2x2, NTLJF4156N) in a synchronous converter

Featured Devices:

µCOOL™ 2x2 mm

P-channel:

NTLJF3117P

MOSFET: 20 VDS/8 VGS, 75 m Ω R_{DS(on)}, Schottky: 0.4V@1A, 2 A maximum current

NTLJF1103P

MOSFET: 8 VDS/6 VGS, 70 m Ω R_{DS(on)},

Schottky: <u>0.4V@1A</u>-channel:, 2 A maximum current

N-channel

NTLJF4156N

MOSFET: 30 VDS/8 VGS, 47 m Ω R_{DS(on)},

Schottky: 0.4V@1A, 2 A maximum current, 30 V reverse

voltage

NTLJF3118N

MOSFET: 20 VDS/12 VGS, 50 m Ω R_{DS(on)}, Schottky: 0.4V@1A, 2 A maximum current

ON Semiconductor and the registered trademarks of Semiconductor Components Industries, LLC (SCILLC). SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

PUBLICATION ORDERING INFORMATION

LITERATURE FULFILLMENT:

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303–675–2175 or 800–344–3860 Toll Free USA/Canada

Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com N. American Technical Support: 800–282–9855 Toll Free USA/Canada

Europe, Middle East and Africa Technical Support: Phone: 421 33 790 2910

Japan Customer Focus Center Phone: 81–3–5773–3850 ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative